Am29LV008T/Am29LV008B

8 Megabit (1,048,576 x 8-Bit) CMOS 3.0 Volt-only, Sectored Flash Memory

DISTINCTIVE CHARACTERISTICS

Single power supply operation

- Extended voltage range: 2.7 to 3.6 volt read and write operations for battery-powered applications
- Standard voltage range: 3.0 to 3.6 volt read and write operations and for compatibility with high performance 3.3 volt microprocessors

High performance

- Extended voltage range: access times as fast as 100 ns
- Standard voltage range: access times as fast as 90 ns

Ultra low power consumption

- Automatic Sleep Mode: 200 nA typical
- Standby mode: 200 nA typical
- Read mode: 2 mA/MHz typical
- Program/erase mode: 20 mA typical

Flexible sector architecture

- One 16 Kbyte, two 8 Kbyte, one 32 Kbyte, and fifteen 64 Kbyte sectors
- Supports control code and data storage on a single device
- Sector Protection features:

A hardware method of locking a sector to prevent any program or erase operations within that sector

Temporary Sector Unprotect feature allows code changes in previously locked sectors

Top or bottom boot block configurations available

Embedded Algorithms

- Embedded Erase algorithms automatically preprogram and erase the entire chip or any combination of designated sectors
- Embedded Program algorithms automatically write and verify bytes or words at specified addresses
- Minimum 100,000 write cycle guarantee per sector
- Package option
 - 40-pin TSOP

Compatibility with JEDEC standards

- Pinout and software compatible with singlepower supply Flash
- Superior inadvertent write protection

Data Polling and toggle bits

 Provides a software method of detecting program or erase operation completion

Ready/Busy pin

 Provides a hardware method of detecting program or erase cycle completion

Erase suspend/resume feature

- Provides the ability to suspend the erase operation in any sector, read data from or program data to any other sector, then return to the original sector and complete the initial erase operation
- Hardware reset pin (RESET)
 - Hardware method to reset the device to the read mode

GENERAL DESCRIPTION

The Am29LV008 is an 8 Mbit, 3.0 Volt-only Flash memory organized as 512 Kbytes of 8 bits each. For flexible erase and program capability, the 512 Kbits of data is divided into 19 sectors of one 16 Kbyte, two 8 Kbyte, one 32 Kbyte, and fifteen 64 Kbytes. The data appears on DQ0-DQ7. The Am29LV008 is offered in a 40-pin TSOP package. This device is designed to be programmed in-system with the standard system 3.0 volt V_{CC} supply. The device can also be reprogrammed in standard EPROM programmers.

The Am29LV008 provides two levels of performance. The first level offers access times as fast as 100 ns with a V_{CC} range as low as 2.7 volts, which is optimal for battery powered applications. The second level offers a

3.0 V-only Flash

This document contains information on a product under development at Advanced Micro Devices. The information is intended to help you evaluate this product. AMD reserves the right to change or discontinue work on this proposed product without notice.

90 ns access time, optimizing performance in systems where the power supply is in the regulated range of 3.0 to 3.6 volts. To eliminate bus contention, the device has separate chip enable (\overline{CE}), write enable (\overline{WE}), and output enable (\overline{OE}) controls.

The Am29LV008 is entirely command set-compatible with the JEDEC single-power-supply Flash standard. Commands are written to the command register using standard microprocessor write timings. Register contents serve as input to an internal state-machine that controls the erase and programming circuitry. Write cycles also internally latch addresses and data needed for the programming and erase operations. Reading data out of the device is similar to reading from other Flash or EPROM devices.

The Am29LV008 is programmed by executing the program command sequence. This invokes the Embedded Program Algorithm, which is an internal algorithm that automatically times the program pulse widths and verifies proper cell margin. The device is erased by executing the erase command sequence. This invokes the Embedded Erase Algorithm, which is an internal algorithm that automatically preprograms the array, if it is not already programmed, before executing the erase operation. During erase, the device automatically times the erase pulse widths and verifies proper cell margin.

This device also features a sector erase architecture. This allows for sectors of memory to be erased and reprogrammed without affecting the data contents of other sectors. A sector is typically erased and verified within 1.0 second. The Am29LV008 is fully erased when shipped from the factory. The Am29LV008 device also features hardware sector protection, implemented via external programming equipment, which disables both program and erase operations in any combination of the memory sectors.

The Erase Suspend feature enables the user to pause the erase operation, for any period of time, to read data from or program data to a sector that was not being erased. Thus, true background erase can be achieved.

The device features 3.0 volt, single-power-supply operation for both read and write functions. Internally generated and regulated voltages are provided for the program and erase operations. A low V_{CC} detector automatically inhibits write operations during power transitions. The end of program or erase is detected by the RY/BY pin. Data Polling of DQ7, or by the Toggle Bit (DQ6). Once the end of a program or erase cycle has been completed, the device automatically resets to the read mode.

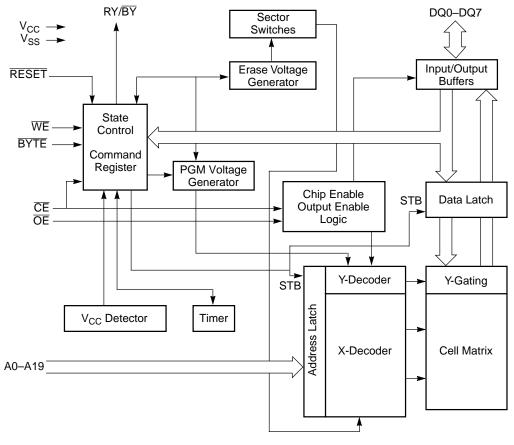
The Am29LV008 also has a hardware RESET pin. When this pin is driven low, execution of any Embedded Program or Erase Algorithm will be terminated. The internal state machine is then be reset into the read mode. Resetting the device will enable the system's microprocessor to read the boot-up firmware from the Flash memory.

AMD's Flash technology combines years of Flash memory manufacturing experience to produce the highest levels of quality, reliability and cost effectiveness. The Am29LV008 memory electrically erases all bits within a sector simultaneously via Fowler-Nordheim tunneling. The bytes are programmed one byte at a time using the EPROM programming mechanism of hot electron injection.

PRODUCT SELECTOR GUIDE

| Family Part Number | | Am29LV008T/Am29LV008B | | | | | | | |
|--|------|-----------------------|------|------|--|--|--|--|--|
| Ordering Part Number: $V_{CC} = 3.0-3.6 V$ | -90R | | | | | | | | |
| V _{CC} = 2.7–3.6 V | | -100 | -120 | -150 | | | | | |
| Max access time (ns) | 90 | 100 | 120 | 150 | | | | | |
| CE access time (ns) | 90 | 100 | 120 | 150 | | | | | |
| OE access time (ns) | 40 | 40 | 50 | 55 | | | | | |

BLOCK DIAGRAM



3.0 V-only Flash

CONNECTION DIAGRAMS

| A16 🗆 🔤 | 1 | 40 | A17 |
|---------|----|----|--|
| A15 🗆 🔤 | 2 | 39 | V _{SS} |
| A14 💷 🔤 | 3 | 38 | |
| A13 | 4 | 37 | —— A19 |
| A12 | 5 | 36 | —————————————————————————————————————— |
| | | | |
| A11 📖 | 6 | 35 | DQ7 |
| A9 🗆 🔤 | 7 | 34 | DQ6 |
| A8 🗆 🔤 | 8 | 33 | DQ5 |
| WE | 9 | 32 | DQ4 |
| | 10 | 31 | |
| | | - | |
| | 11 | 30 | |
| RY/BY | 12 | 29 | NC |
| A18 🗆 🔤 | 13 | 28 | DQ3 |
| A7 💷 | 14 | 27 | DQ2 |
| A6 | 15 | 26 | DQ1 |
| | | | |
| A5 | 16 | 25 | DQ0 |
| A4 💷 | 17 | 24 | |
| A3 🗆 🔤 | 18 | 23 | V _{SS} |
| A2 💷 | 19 | 22 | |
| A1 | 20 | 21 | A0 |
| | 20 | 21 | AU |

Standard 40-Pin TSOP

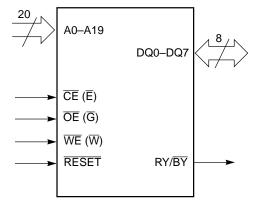
| A17 📖 | 1 🗸 | 0 40 | ——— A16 |
|-----------------|-----|------|-------------------------|
| V _{SS} | 2 | 39 | ——— A15 |
| NC | 3 | 38 | ——— A14 |
| A19 📖 | 4 | 37 | ——— A13 |
| A10 📖 | 5 | 36 | ——— A12 |
| DQ7 📖 | 6 | 35 | ——— A11 |
| DQ6 | 7 | 34 | ——— A9 |
| DQ5 | 8 | 33 | —— A8 |
| DQ4 | 9 | 32 | WE |
| V _{CC} | 10 | 31 | ESET RESET |
| V _{CC} | 11 | 30 | NC |
| NC | 12 | 29 | ──── RY/ B Y |
| DQ3 | 13 | 28 | ——— A18 |
| DQ2 | 14 | 27 | A7 |
| DQ1 | 15 | 26 | A6 |
| DQ0 | 16 | 25 | A5 |
| | 17 | 24 | A4 |
| V _{SS} | 18 | 23 | A3 |
| | 19 | 22 | A2 |
| A0 | 20 | 21 | A1 |
| | | | |

Reverse 40-Pin TSOP

PIN CONFIGURATION

| A0–A19 | = | 20 addresses |
|-----------------|---|---|
| DQ0–DQ7 | = | 8 data inputs/outputs |
| CE | = | Chip enable |
| ŌĒ | = | Output enable |
| WE | = | Write enable |
| RESET | = | Hardware reset pin, active low |
| RY/BY | = | Ready/Busy output |
| V _{CC} | = | Standard voltage range (3.0 V to 3.6 V) for -90R |
| | | Extended voltage range (2.7 to 3.6 V) for -100, -120, -150 |
| V _{SS} | = | Device ground |
| NC | = | Pin not connected internally |

LOGIC SYMBOL



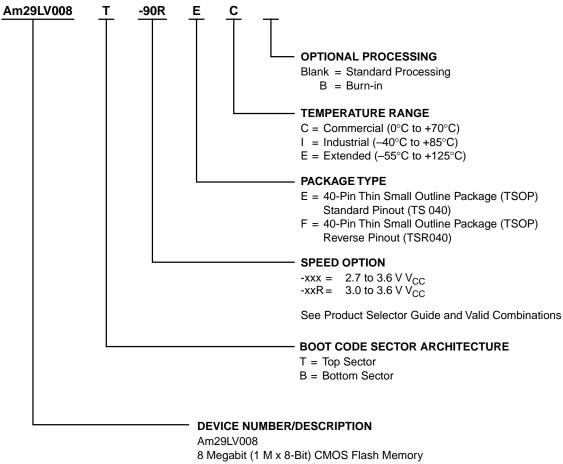
20511C-3

3.0 V-only Flash

ORDERING INFORMATION

Standard Products

AMD standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of the elements below.



3.0 Volt-only Program and Erase

| Valid Combinations | | | | | | | | | |
|-----------------------------------|-------------------------------------|--|--|--|--|--|--|--|--|
| Am29LV008T-90R, Am29LV008B-90R | EC, EI, FC, FI | | | | | | | | |
| V _{CC} = 3.0–3.6 V | | | | | | | | | |
| Am29LV008T-100, Am29LV008B-100 | | | | | | | | | |
| Am29LV008T-120, Am29LV008B-120 | EC, EI, EE, EEB, FC, FI, FE, FEB | | | | | | | | |
| Am29LV008T-150, Am29LV008B-150 | | | | | | | | | |

Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations and to check on newly released combinations.

Table 1. Am29LV008 User Bus Operations

| Operation | CE | ŌĒ | WE | A0 | A1 | A6 | A9 | DQ0-DQ7 | RESET |
|---|----|-----------------|---------|----|----|----|-----------------|-------------|-----------------|
| Autoselect, Manufacturer Code (Note 1) | L | L | н | L | L | L | V _{ID} | Code | н |
| Autoselect, Device Code (Note 1) | L | L | н | н | L | L | V _{ID} | Code | н |
| Read | L | L | н | A0 | A1 | A6 | A9 | RD | н |
| Standby | Н | Х | Х | Х | Х | Х | Х | HIGH Z | н |
| Output Disable | L | н | н | Х | Х | Х | Х | HIGH Z | н |
| Write | L | н | L | A0 | A1 | A6 | A9 | PD (Note 2) | Н |
| Enable Sector Protect (Note 3) | L | V _{ID} | Pulse/H | L | Н | L | V _{ID} | Code | н |
| Verify Sector Protect (Note 4) | L | L | н | L | Н | L | V _{ID} | Code | н |
| Temporary Sector Unprotect | Х | Х | X | Х | Х | Х | Х | Х | V _{ID} |
| Reset | Х | Х | Х | Х | Х | Х | Х | HIGH Z | L |

Legend:

 $L = V_{IL}$, $H = V_{IH}$, $V_{ID} = 12.0 V \pm 5\%$, X = Don't care. See "DC Characteristics" on page 26 for voltage levels.

PD = program data, RD = read data. Refer to Table 3 on page 10 for more information.

Notes:

1. Manufacturer and device codes may also be accessed via a command register write sequence. Refer to Table 5 on page 13.

2. Refer to Table 5 for valid PD during a write operation.

3. Set $V_{CC} = 3.0$ volts $\pm 10\%$.

4. Refer to "Sector Protection" on page 12.

USER BUS OPERATIONS

Read Mode

The Am29LV008 has three control functions which must be satisfied in order to obtain data at the outputs:

- CE is the power control and should be used for device selection (CE = V_{IL})
- OE is the output control and should be used to gate data to the output pins if the device is selected (OE = V_{II})
- WE remains at V_{IH}

Address access time (T_{ACC}) is equal to the delay from stable addresses to valid output data. The chip enable access time (T_{CE}) is the delay from stable addresses and stable \overline{CE} to valid data at the output pins. The output enable access time (T_{OE}) is the delay from the falling edge of \overline{OE} to valid data at the output pins (assuming the addresses have been stable at least $T_{ACC} - T_{OE}$ time).

Standby Mode

The Am29LV008 is designed to accommodate low standby power consumption by applying the following voltages to the \overline{CE} and \overline{RESET} pins: I_{CC3} for CMOS compatible I/Os (current consumption <5 μA max.) is enabled when a CMOS logic level '1' ($V_{CC} \pm 0.3$ V) is applied to the \overline{CE} control pin with $\overline{RESET} = V_{CC} \pm 0.3$ V. While in the I_{CC3} standby mode, the data I/O pins remain in the high impedance state independent of the voltage level applied to the \overline{OE} input. See the DC Characteristics section for more details on Standby Modes.

Deselecting \overline{CE} (\overline{CE} and $\overline{RESET} = V_{CC} \pm 0.3 \text{ V}$) puts the device into the I_{CC3} standby mode. If the device is deselected during an Embedded Algorithm operation, it continues to draw active power (I_{CC2}) prior to entering the standby mode, until the operation is complete. When the device is again selected ($\overline{CE} = V_{IL}$), active operations occur in accordance with the AC timing specifications.

Automatic Sleep Mode

Advanced power management features such as the automatic sleep mode minimize Flash device energy consumption. This is extremely important in battery-powered applications. The Am29LV008 automatically enables the low-power, automatic sleep mode when addresses remain stable for 200 ns. Automatic sleep mode is independent of the \overline{CE} , \overline{WE} , and \overline{OE} control signals. Typical sleep mode current draw is 200 nA (for CMOS-compatible operation). Standard addresses are changed. While in sleep mode, output data is latched and always available to the system.

Output Disable

If the \overline{OE} input is at a logic high level (V_{IH}), output from the device is disabled. This will cause the output pins to be in a high impedance state.

Autoselect

The Autoselect mode allows the reading out of a binary code from the device and will identify its manufacturer and type. The intent is to allow programming equipment to automatically match the device to be programmed with its corresponding programming algorithm. The Autoselect command may also be used to check the status of write-protected sectors (see Table 2). This mode is functional over the entire temperature range of the device.

To activate this mode, the programming equipment must force V_{ID} (12.0 V ± 5%) on address pin A9. Two identifier bytes may then be sequenced from the device outputs by toggling address A0 from V_{IL} to V_{IH}. All addresses are don't cares except A0, A1, and A6 see Table 2.

The manufacturer and device codes may also be read via the command register, for instances when the

Am29LV008 is erased or programmed in a system without access to high voltage on the A9 pin. The command sequence is illustrated in Table 5 on page 13.

Byte 0 (A0 = V_{IL}) represents the manufacturer's code and byte 1 (A0 = V_{IH}) the device identifier code. For the Am29LV008 these two bytes are given in Table 2. All identifiers for manufacturer and device will exhibit odd parity with DQ7 defined as the parity bit. In order to read the proper device codes when executing Autoselect, A1 must be V_{IL} (see Table 2). The device code is 3EH (for top boot block) or 37H (for bottom boot block).

In order to determine which sectors are write protected, A1 must be at V_{IH} while running through the sector addresses; if the selected sector is protected, a logical '1' will be output on DQ0 (DQ0 = 1).

| | Table 2. Autoselect/Sector Protection Codes | | | | | | | | | | | | |
|---------------------------------------|---|----|----|----|---------------|---------|---------|---------|---------|---------|---------|---------|---------|
| Туре | A13–A19 | A6 | A1 | A0 | Code (HEX) | DQ 7 | DQ 6 | DQ 5 | DQ 4 | DQ 3 | DQ 2 | DQ 1 | DQ 0 |
| Manufacturer Code: AMD | Х | L | L | L | 01H | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| 29LV008 Device (Top Boot Block) | х | L | L | н | 3EH | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 0 |
| 29LV008 Device (Bottom Boot Block) | х | L | L | Н | 37H | 0 | 0 | 1 | 1 | 0 | 1 | 1 | 1 |
| Sector Protection | Set Sector Addresses | L | Н | L | 01H* | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |

X = Don't care.

* Outputs 01H at protected sector addresses.

| | A19 | A18 | A17 | A16 | A15 | A14 | A13 | Sector Size | Address Range | | |
|------|-----|-----|-----|-----|-----|-----|-----|-------------|---------------|--|--|
| SA0 | 0 | 0 | 0 | 0 | Х | Х | Х | 64 Kbytes | 00000h-0FFFFh | | |
| SA1 | 0 | 0 | 0 | 1 | Х | Х | Х | 64 Kbytes | 10000h-1FFFFh | | |
| SA2 | 0 | 0 | 1 | 0 | Х | Х | Х | 64 Kbytes | 20000h-2FFFFh | | |
| SA3 | 0 | 0 | 1 | 1 | Х | Х | Х | 64 Kbytes | 30000h-3FFFFh | | |
| SA4 | 0 | 1 | 0 | 0 | Х | Х | Х | 64 Kbytes | 40000h-4FFFFh | | |
| SA5 | 0 | 1 | 0 | 1 | Х | Х | Х | 64 Kbytes | 50000h-5FFFFh | | |
| SA6 | 0 | 1 | 1 | 0 | Х | Х | Х | 64 Kbytes | 60000h-6FFFFh | | |
| SA7 | 0 | 1 | 1 | 1 | Х | Х | Х | 64 Kbytes | 70000h-7FFFFh | | |
| SA8 | 1 | 0 | 0 | 0 | Х | Х | Х | 64 Kbytes | 80000h-8FFFFh | | |
| SA9 | 1 | 0 | 0 | 1 | Х | Х | Х | 64 Kbytes | 90000h-9FFFFh | | |
| SA10 | 1 | 0 | 1 | 0 | Х | Х | Х | 64 Kbytes | A0000h-AFFFFh | | |
| SA11 | 1 | 0 | 1 | 1 | Х | Х | Х | 64 Kbytes | B0000h-BFFFFh | | |
| SA12 | 1 | 1 | 0 | 0 | Х | Х | Х | 64 Kbytes | C0000h-CFFFFh | | |
| SA13 | 1 | 1 | 0 | 1 | Х | Х | Х | 64 Kbytes | D0000h-DFFFFh | | |
| SA14 | 1 | 1 | 1 | 0 | Х | Х | Х | 64 Kbytes | E0000h-EFFFFh | | |
| SA15 | 1 | 1 | 1 | 1 | 0 | Х | Х | 32 Kbytes | F0000h-F7FFFh | | |
| SA16 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 8 Kbytes | F8000h-F9FFFh | | |
| SA17 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 8 Kbytes | FA000h-FBFFFh | | |
| SA18 | 1 | 1 | 1 | 1 | 1 | 1 | Х | 16 Kbytes | FC000h-FFFFFh | | |

Table 3. Sector Address Tables (Am29LV008T)

| | | | | lable 4. | Sector Address Tables (Am29LV008B) | | | | | | | | |
|------|-----|-----|-----|----------|------------------------------------|-----|-----|-------------|---------------|--|--|--|--|
| | A19 | A18 | A17 | A16 | A15 | A14 | A13 | Sector Size | Address Range | | | | |
| SA0 | 0 | 0 | 0 | 0 | 0 | 0 | Х | 16 Kbytes | 00000h-03FFFh | | | | |
| SA1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 8 Kbytes | 04000h-05FFFh | | | | |
| SA2 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 8 Kbytes | 06000h-07FFFh | | | | |
| SA3 | 0 | 0 | 0 | 0 | 1 | Х | Х | 32 Kbytes | 08000h-0FFFFh | | | | |
| SA4 | 0 | 0 | 0 | 1 | Х | Х | Х | 64 Kbytes | 10000h-1FFFFh | | | | |
| SA5 | 0 | 0 | 1 | 0 | Х | Х | Х | 64 Kbytes | 20000h-2FFFFh | | | | |
| SA6 | 0 | 0 | 1 | 1 | Х | Х | Х | 64 Kbytes | 30000h-3FFFFh | | | | |
| SA7 | 0 | 1 | 0 | 0 | Х | Х | Х | 64 Kbytes | 40000h-4FFFFh | | | | |
| SA8 | 0 | 1 | 0 | 1 | Х | Х | Х | 64 Kbytes | 50000h-5FFFFh | | | | |
| SA9 | 0 | 1 | 1 | 0 | Х | Х | Х | 64 Kbytes | 60000h-6FFFFh | | | | |
| SA10 | 0 | 1 | 1 | 1 | Х | Х | Х | 64 Kbytes | 70000h-7FFFFh | | | | |
| SA11 | 1 | 0 | 0 | 0 | Х | Х | Х | 64 Kbytes | 80000h-8FFFFh | | | | |
| SA12 | 1 | 0 | 0 | 1 | Х | Х | Х | 64 Kbytes | 90000h-9FFFFh | | | | |
| SA13 | 1 | 0 | 1 | 0 | Х | Х | Х | 64 Kbytes | A0000h-AFFFFh | | | | |
| SA14 | 1 | 0 | 1 | 1 | Х | Х | Х | 64 Kbytes | B0000h-BFFFFh | | | | |
| SA15 | 1 | 1 | 0 | 0 | Х | Х | Х | 64 Kbytes | C0000h-CFFFFh | | | | |
| SA16 | 1 | 1 | 0 | 1 | Х | х | Х | 64 Kbytes | D0000h-DFFFFh | | | | |
| SA17 | 1 | 1 | 1 | 0 | Х | х | Х | 64 Kbytes | E0000h-EFFFFh | | | | |
| SA18 | 1 | 1 | 1 | 1 | Х | Х | Х | 64 Kbytes | F0000h-FFFFFh | | | | |

Table 4. Sector Address Tables (Am29LV008B)

Write

Device erasure and programming are accomplished via the command register. The command register is written by bringing \overline{WE} to V_{IL} , while \overline{CE} is at V_{IL} and \overline{OE} is at V_{IH} . Addresses are latched on the falling edge of \overline{CE} or \overline{WE} , whichever occurs later, while data is latched on the rising edge of the \overline{CE} or \overline{WE} pulse, whichever occurs first. Standard microprocessor write timings are used.

Refer to AC Write Characteristics and the Erase/ Programming Waveforms for specific timing parameters.

Sector Protection

Sectors of the Am29LV008 may be hardware protected at the user's factory with external programming equipment. The protection circuitry will disable both program and erase functions for the protected sectors, making the protected sectors read-only. Requests to program or erase a protected sector will be ignored by the device. If the user attempts to write to a protected sector, DATA Polling will be activated for about 1 μ s; the device will then return to read mode, with data from the protected sector, Toggle Bit will be activated for about 50 μ s; the device will then return to read mode, without having erased the protected sector.

It is possible to determine if a sector is protected in the system by writing an Autoselect command. Performing a read operation at the address location XX02H, where the higher order address A18–A12 represents the sector address, will produce a logical '1' at DQ0 for a protected sector.

Temporary Sector Unprotect

The sectors of the Am29LV008 may be temporarily unprotected by raising the RESET pin to 12.0 volts (V_{ID}). During this mode, formerly protected sectors can be programmed or erased with standard command sequences by selecting the appropriate byte or sector addresses. Once the RESET pin goes to V_{IH}, all the previously protected sectors will be protected again.

Command Definitions

Device operations are selected by writing specific address and data sequences into the command register. Writing incorrect address and data values or writing them in the improper sequence will reset the device to the read mode. Table 5 on page 13 defines the valid register command sequences. Note that the Erase Suspend (B0H) and Erase Resume (30H) commands are valid only while the Sector Erase operation is in progress.

Read/Reset Command

The device will automatically power up in the read/ reset state. In this case, a command sequence is not required to read data. Standard microprocessor cycles will retrieve array data. This default value ensures that no spurious alteration of the memory content occurs during the power transition. Refer to the AC Characteristics section for the specific timing parameters.

The read or reset operation is initiated by writing the read/reset command sequence into the command register. Microprocessor read cycles retrieve array data from the memory. The device remains enabled for reads until the command register contents are altered.

Autoselect Command

Flash memories are intended for use in applications where the local CPU alters memory contents. As such, manufacturer and device codes must be accessible while the device resides in the target system. The Am29LV008 contains an autoselect command operation that provides device information and sector protection status to the system. The operation is initiated by writing the autoselect command sequence into the command register. Following the command write, a read cycle from address XX00H retrieves the manufacturer code of 01H. A read cycle from address XX01H returns the device code 3EH (for top boot device) or 37H (for bottom boot device); see Table 2 on page 9. All manufacturer and device codes will exhibit odd parity with the MSB of the lower byte (DQ7) defined as the parity bit. Scanning the sector addresses (A13, A14, A15, A16, A17, A18, and A19) while (A6, A1, A0) = (0, 1, 0) will produce a logical '1' code at device output DQ0 for a write protected sector (See Table 2).

To terminate the Autoselect operation, it is necessary to write the read/reset command sequence into the register.

| Command Sequence Read/Reset | Bus Write Cycles | First Bus Write Cycle | | Second Bus Read/Write Cycle | | Third Bus Write Cycle | | Fourth Bus Read/Write Cycle | | Fifth Bus Write Cycle | | Sixth Bus Write Cycle | |
|--|------------------------|--------------------------|------|-----------------------------------|------|--------------------------|------|-----------------------------------|------|--------------------------|------|--------------------------|------|
| (Note 2) | Req'd | Addr | Data | Addr | Data | Addr | Data | Addr | Data | Addr | Data | Addr | Data |
| Reset/Read | 1 | XXX | F0 | RA | RD | | | | | | | | |
| Autoselect Manufacturer ID | 3 | 555 | AA | 2AA | 55 | 555 | 90 | X00 | 01 | | | | |
| Autoselect Device ID (Top Boot Block) | 3 | 555 | AA | 2AA | 55 | 555 | 90 | X01 | 3E | | | | |
| Autoselect Device ID (Bottom Boot Block) | 3 | 555 | AA | 2AA | 55 | 555 | 90 | X01 | 37 | | | | |
| Autoselect | | | | | | | | SA | 00 | | | | |
| Sector Protect Verify (Note 3) | 3 | 555 | AA | 2AA | 55 | 555 | 90 | X02 | 01 | | | | |
| Byte Program | 4 | 555 | AA | 2AA | 55 | 555 | A0 | PA | PD | | | | |
| Chip Erase | 6 | 555 | AA | 2AA | 55 | 555 | 80 | 555 | AA | 2AA | 55 | 555 | 10 |
| Sector Erase | 6 | 555 | AA | 2AA | 55 | 555 | 80 | 555 | AA | 2AA | 55 | SA | 30 |
| Erase Suspend (Note 4) | 1 | xxx | B0 | | | | | | | | | | |
| Erase Resume (Note 5) | 1 | xxx | 30 | | | | | | | | | | |

Table 5. Am29LV008 Command Definitions

Legend:

RA = *Address of the memory location to be read.*

RD = Data read from location RA during read operation.

PA = Address of the memory location to be programmed. Addresses are latched on the falling edge of the WE or CE pulse.

PD = Data to be programmed at location PA. Data is latched on the rising edge of \overline{WE} or \overline{CE} pulse.

SA = Address of the sector to be erased or verified. Address bits A19–A13 uniquely select any sector.

Notes:

- 1. All values are in hexadecimal.
- 2. See Table 1 for description of bus operations.
- 3. The data is 00h for an unprotected sector and 01h for a protected sector. The complete bus address is composed of the sector address on A19–A13 and 02h on A7–A0.
- 4. Read and program functions in non-erasing sectors are allowed in the Erase Suspend mode. The Erase Suspend command is valid only during a sector erase operation.
- 5. The Erase Resume command is valid only during the Erase Suspend mode.
- 6. Unless otherwise noted, address bits A19-A11 = X = don't care.

Byte Programming

The device is programmed on a byte-by-byte basis. Programming is a four-bus-cycle operation. There are two "unlock" write cycles. These are followed by the program command and address/data write cycles. Addresses are latched on the falling edge of \overline{CE} or \overline{WE} , whichever occurs later, while the data is latched on the rising edge of \overline{CE} or \overline{WE} , whichever occurs first. The rising edge of \overline{CE} or \overline{WE} , whichever occurs first, initiates programming using the Em-

bedded Program Algorithm. Upon executing the write command, the system is **not** required to provide further controls or timing. The device will automatically provide adequate internally generated program pulses and verify the programmed cell margin.

The status of the Embedded Program Algorithm operation can be determined three ways:

■ DATA Polling of DQ7

3.0 V-only Flash

- Checking the status of the toggle bit DQ6
- Checking the status of the RY/BY pin

Any commands written to the chip during the Embedded Program Algorithm will be ignored. If a hardware reset occurs during a programming operation, the data at that location will be corrupted.

Programming is allowed in any sequence and across sector boundaries. Beware that a data '0' cannot be programmed back to a '1'. Attempting to do so will cause the device to exceed programming time limits (DQ5 = 1) or result in an apparent success according to the data polling algorithm. However, reading the device after executing the Read/Reset operation will show that the data is still '0'. Only erase operations can convert '0's to '1's.

Figure 4 illustrates the Embedded Program Algorithm, using typical command strings and bus operations.

Chip Erase

Chip erase is a six bus cycle operation. There are two "unlock" write cycles, followed by writing the erase "set up" command. Two more "unlock" write cycles are followed by the chip erase command.

Chip erase does **not** require the user to preprogram the device to all '0's prior to erase. Upon executing the Embedded Erase Algorithm command sequence, the device automatically programs and verifies the entire memory to an all zero data pattern prior to electrical erase. The system is not required to provide any controls or timings during these operations.

The Embedded Erase Algorithm erase begins on the rising edge of the last \overline{WE} or \overline{CE} (whichever occurs first) pulse in the command sequence. The status of the Embedded Erase Algorithm operation can be determined three ways:

- DATA Polling of DQ7
- Checking the status of the toggle bit DQ6
- Checking the status of the RY/BY pin

Figure 5 illustrates the Embedded Erase Algorithm, using a typical command sequence and bus operations.

Sector Erase

Sector erase is a six bus cycle operation. There are two "unlock" writes. These are followed by writing the erase "set up" command. Two more "unlock" writes are followed by the Sector Erase command (30H). The sector address (any address location within the desired sector) is latched on the falling edge of \overline{WE} or \overline{CE} (whichever occurs last) while the command (30H) is latched on the rising edge of \overline{WE} or \overline{CE} (whichever occurs first).

Multiple sectors can be specified for erase by writing the six bus cycle operation as described above and

then following it by additional writes of the Sector Erase command to addresses of other sectors to be erased. The time between Sector Erase command writes must be less than 80 µs, otherwise that command will not be accepted. It is recommended that processor interrupts be disabled during this time to guarantee this condition. The interrupts can be re-enabled after the last Sector Erase command is written. A time-out of 80 µs from the rising edge of the last \overline{WE} (or \overline{CE}) will initiate the execution of the Sector Erase command(s). If another falling edge of the \overline{WE} (or \overline{CE}) occurs within the 80 µs time-out window, the timer is reset. During the 80 µs window, any command other than Sector Erase or Erase Suspend written to the device will reset the device back to Read mode. Once the 80 µs window has timed out, only the Erase suspend command is recognized. Note that although the Reset command is not recognized in the Erase Suspend mode, the device is available for read or program operations in sectors that are not erase suspended. The Erase Suspended and Erase Resume commands may be written as often as required during a sector erase operation. Hence, once erase has begun, it must ultimately complete unless Hardware Reset is initiated. Loading the sector erase registers may be done in any sequence and with any number of sectors (0 to 18).

Sector erase does **not** require the user to program the device prior to erase. The device automatically preprograms all memory locations, within sectors to be erased, prior to electrical erase. When erasing a sector or sectors, the remaining unselected sectors or the write protected sectors are unaffected. The system is not required to provide any controls or timings during sector erase operations. The Erase Suspend and Erase Resume commands may be written as often as required during a sector erase operation.

Automatic sector erase operations begin on the rising edge of the \overline{WE} (or \overline{CE}) pulse of the last sector erase command issued, and once the 80 μ s time-out window has expired. The status of the sector erase operation can be determined three ways:

- DATA Polling of DQ7
- Checking the status of the toggle bit DQ6
- Checking the status of the RY/BY pin

Further status of device activity during the sector erase operation can be determined using toggle bits DQ2 and DQ3.

Figure 5 illustrates the Embedded Erase Algorithm, using a typical command sequence and bus operations.

Erase Suspend

The Erase Suspend command allows the user to interrupt a Sector Erase operation and then perform data read or programs in a sector not being erased. This command is applicable only during the Sector Erase operation, which includes the time-out period for Sector Erase. The Erase Suspend command will be ignored if written during the execution of the Chip Erase operation or Embedded Program Algorithm (but will reset the chip if written improperly during the command sequences.) Writing the Erase Suspend command during the Sector Erase time-out results in immediate termination of the time-out period and suspension of the erase operation. Once in Erase Suspend, the device is available for read (note that in the Erase Suspend mode, the Reset/Read command is not required for read operations and is ignored) or program operations in sectors not being erased. Any other command written during the Erase Suspend mode will be ignored, except for the Erase Resume command. Writing the Erase Resume command resumes the sector erase operation. The addresses are "don't cares" when writing the Erase Suspend or Erase Resume command.

When the Erase Suspend command is written during a Sector Erase operation, the chip will take between 0.1 μ s and 20 μ s to actually suspend the operation and go into erase suspended read mode (pseudo-read mode), at which time the user can read or program from a sector that is **not** erase suspended. Reading data in this mode is the same as reading from the standard read mode, except that the data must be read from sectors that have not been erase suspended.

Successively reading from the erase-suspended sector while the device is in the erase-suspend-read mode will cause DQ2 to toggle. Polling DQ2 on successive reads from a given sector provides the system the ability to determine if a sector is in Erase Suspend.

After entering the erase-suspend-read mode, the user can program the device by writing the appropriate command sequence for Byte Program. This program mode is known as the erase suspend-program mode. Again, programming in this mode is the same as programming in the regular Byte Program mode, except that the data must be programmed to sectors that are not erase suspended. Successively reading from the erase suspended sector while the device is in the erase suspend-program mode will cause DQ2 to toggle. Completion of the erase suspend operation can be determined two ways:

- Checking the status of the toggle bit DQ2
- Checking the status of the RY/BY pin

To resume the operation of Sector Erase, the Resume command (30H) should be written. Any further writes of the Resume command at this point will be ignored. However, another Erase Suspend command can be written after the device has resumed sector erase operations.

When the erase operation has been suspended, the device defaults to the erase-suspend-read mode. Reading data in this mode is the same as reading from the standard read mode except that the data must be read from sectors that have not been erase-suspended.

To resume the operation of Sector Erase, the Resume command (30H) should be written. Any further writes of the Resume command at this point will be ignored. Another Erase Suspend command can be written after the chip has resumed erasing.

Write Operation Status

Address Sensitivity of Write Status Flags

Detailed in Table 6 are all the status flags that can be used to check the status of the device for current mode operation. During Sector Erase, the part provides the status flags automatically to the I/O ports. The information on DQ2 is address sensitive. This means that if an address from an erasing sector is consecutively read, then the DQ2 bit will toggle. However, DQ2 will not toggle if an address from a non-erasing sector is consecutively read. This allows the user to determine which sectors are erasing and which are not.

Once Erase Suspend is entered, address sensitivity still applies. If the address of a non-erasing sector (that is, one available for read) is provided, then stored data can be read from the device. If the address of an erasing sector (that is, one unavailable for read) is applied, the device will output its status bits. Confirmation of status bits can be done by doing consecutive reads to toggle DQ2, which is active throughout the Embedded Erase mode, including Erase Suspend.

In order to effectively use DATA Polling to determine if the device has entered into erase-suspended mode, it is necessary to apply a sector address from a sector being erased.

| | | Status | DQ7 | DQ6 | DQ5 | DQ3 | DQ2 | RY/BY |
|-------------------------|-----------------|--------------------------|-----------------|-----------|------|------|--------------------|-------|
| | Programm | ning | DQ7 | Toggle | 0 | 0 | No Toggle | 0 |
| | Program/E | Erase in Auto-Erase | 0 | Toggle | 0 | 1 | (Note 1) | 0 |
| In Progress | Erase | Erase Sector Address | 1 | No Toggle | 0 | 0 | Toggle (Note 1) | 1 |
| | Suspend Mode | Non-Erase Sector Address | Data | Data | Data | Data | Data (Note 2) | 1 |
| | Program i | n Erase Suspend | DQ7 (Note 2) | Toggle | 0 | 0 | Data 2) | 0 |
| | Programm | ning | DQ7 | Toggle | 1 | 0 | No Toggle | 0 |
| Exceeded Time Limits | Program/E | Erase in Auto-Erase | 0 | Toggle | 1 | 1 | (Note 3) | 0 |
| | Program i | n Erase Suspend | DQ7 | Toggle | 1 | 0 | No Toggle | 0 |

Table 6. Hardware Sequence Flags

Notes:

1. DQ2 can be toggled when the sector address applied is that of an erasing or erase suspended sector. Conversely, DQ2 cannot be toggled when the sector address applied is that of a non-erasing or non-erase suspended sector. DQ2 is therefore used to determine which sectors are erasing or erase suspended and which are not.

2. These status flags apply when outputs are read from the address of a non-erase-suspended sector.

3. If DQ5 is high (exceeded timing limits), successive reads from a problem sector will cause DQ2 to toggle.

DQ7: Data Polling

The Am29LV008 features DATA Polling as a method to indicate to the host system that the embedded algorithms are in progress or completed.

During the Embedded Program Algorithm, an attempt to read the device will produce the compliment of the data last written to DQ7. Upon completion of the Embedded Program Algorithm, an attempt to read the device will produce the true data last written to DQ7. Note that just at the instant when DQ7 switches to true data, the other bits, DQ6–DQ0, may not yet be true data. However, they will all be true data on the next read from the device. **Please note that Data Polling (DQ7) may give an inaccurate result when an attempt is made to write to a protected sector.** During an Embedded Erase Algorithm, an attempt to read the device will produce a '0' at the DQ7 output. Upon completion of the Embedded Erase Algorithm, an attempt to read the device will produce a '1' at DQ7.

For chip erase, the DATA Polling is valid (DQ7 = 1) after the rising edge of the sixth \overline{WE} pulse in the six write pulse sequence. For sector erase, the DATA Polling is valid after the last rising edge of the sector erase \overline{WE} pulse. DATA Polling must be performed at sector addresses within any of the sectors being erased and not a sector that is within a protected sector. Otherwise, the status may not be valid.

Just prior to the completion of Embedded Algorithm operations, DQ7 may change asynchronously while the output enable ($\overline{\text{OE}}$) is asserted low. This means that the

device is driving status information on DQ7 at one instant of time and in the next instance of time, that byte has valid data. Depending on when the system samples the DQ7 output, it may read the status or valid data. Even if the device has completed the Embedded Algorithm operations and DQ7 has valid data, DQ0– DQ6 may still provide write operation status. The valid data on DQ0–DQ7 can be read on the next successive read attempt.

The DATA Polling feature is only active during the Embedded Programming Algorithm, Embedded Erase Algorithm, Erase Suspend, erase suspend-program mode, or sector erase time-out (see Table 6).

If the user attempts to write to a protected sector, $\overline{\text{DATA}}$ Polling will be activated for about 1 µs; the device will then return to read mode, with data from the protected sector unchanged. If the user attempts to erase a protected sector, Toggle Bit will be activated for about 50 µs; the device will then return to read mode, without having erased the protected sector.

See Figure 6 for the DATA Polling timing specifications and diagrams.

DQ6: Toggle Bit

The Am29LV008 also features a "Toggle Bit" as a method to indicate to the host system whether the embedded algorithms are in progress or completed.

During an Embedded Program or Erase Algorithm, successive attempts to read data from the device will result in DQ6 toggling between one and zero. Once the

Embedded Program or Erase Algorithm is completed, DQ6 will stop toggling and valid data can be read on the next successive attempts. During programming, the Toggle Bit is valid after the rising edge of the fourth WE pulse in the four-write-pulse sequence. During Chip erase, the Toggle Bit is valid after the rising edge of the sixth WE pulse in the six-write-pulse sequence. During Sector erase, the Toggle Bit is valid after the last rising edge of the sector erase WE pulse. The Toggle Bit is active during the Sector Erase time-out.

Either \overline{CE} or \overline{OE} toggling will cause DQ6 to toggle. If the user attempts to write to a protected sector, \overline{DATA} Polling will be activated for about 1 µs; the device will then return to read mode, with data from the protected sector unchanged. If the user attempts to erase a protected sector, Toggle Bit will be activated for about 50 µs; the device will then return to read mode, without having erased the protected sector.

DQ5: Exceeded Timing Limits

DQ5 will indicate if the program or erase time has exceeded the specified limits (internal pulse count). Under these conditions, DQ5 will produce a '1' indicating that the program or erase cycle was not successfully completed. Write operation status and reset command are the only operating functions under this condition. The device will draw active power under this condition.

The DQ5 failure condition will also appear if the user attempts to write a data '1' to a bit that has already been programmed to a data '0'. In this case, the DQ5 failure condition is not guaranteed to happen, since the device was incorrectly used. Please note that programming a data '0' to a data '1' should never be attempted, and only erasure should be used for this purpose. If programming to a data '1' is attempted, the device should be reset.

If the DQ5 failure condition is observed while in Sector Erase mode (that is, exceeded timing limits), then DQ2 can be used to determine which sector had the problem. This is especially useful when multiple sectors have been loaded for erase.

DQ3: Sector Erase Timer

After the completion of the initial Sector Erase command sequence, the Sector Erase time-out will begin. DQ3 will remain low until the time-out is complete. DATA Polling (DQ7) and Toggle Bit (DQ6) are also valid after the first sector erase command sequence. If DATA Polling or the Toggle Bit indicates the device has been written with a valid Sector Erase command, DQ3 may be used to determine if the sector erase timer window is still open. If DQ3 is high ('1'), the internally controlled erase cycle has begun; attempts to write subsequent commands to the device will be ignored until the erase operation is completed as indicated by the DATA Polling or Toggle Bit. If DQ3 is low ('0'), the device will accept additional sector erase commands. To be certain the command has been accepted, the software should check the status of DQ3 following each Sector Erase command. If DQ3 was high on the second status check, the command may not have been accepted.

It is recommended that the user guarantee the time between sector erase command writes be less than $80 \,\mu s$ by disabling the processor interrupts just for the duration of the Sector Erase (30H) commands. This approach will ensure that sequential sector erase command writes will be written to the device while the sector erase timer window is still open.

DQ2: Toggle Bit 2

This toggle bit, along with DQ6, can be used to determine whether the device is in the Embedded Erase Algorithm or in Erase Suspend.

Successive reads from the erasing sector will cause DQ2 to toggle during the Embedded Erase Algorithm. If the device is in the erase-suspend-read mode, successive reads from the erase-suspended sector will cause DQ2 to toggle. When the device is in the erase suspend-program mode, successive reads from the byte address of the non-erase suspended sector will indicate a logic '1' at the DQ2 bit. Note that a sector which is selected for erase is not available for read in Erase Suspend mode. Other sectors which are not selected for Erase can be read in Erase Suspend.

DQ6 is different from DQ2 in that DQ6 toggles only when the standard program or erase, or erase suspend-program operation is in progress.

If the DQ5 failure condition is observed while in Sector Erase mode (that is, exceeded timing limits), the DQ2 toggle bit can give extra information. In this case, the normal function of DQ2 is modified. If DQ5 is at logic '1', then DQ2 will toggle with consecutive reads only at the sector address that caused the failure condition. DQ2 will toggle at the sector address where the failure occurred and will not toggle at other sector addresses.

RY/BY: Ready/Busy Pin

The Am29LV008 provides a RY/BY open-drain output pin as a way to indicate to the host system that the Embedded Algorithms are either in progress or have been completed. If the output is low, the device is busy with either a program or erase operation. If the output is high, the device is ready to accept any read/write or erase operation. When the RY/BY pin is low, the device will not accept any additional program or erase commands with the exception of the Erase Suspend command. If the Am29LV008 is placed in an Erase Suspend mode, the RY/ \overline{BY} output will be high. For programming, the RY/ \overline{BY} is valid (RY/ \overline{BY} =0) after the rising edge of the fourth \overline{WE} pulse in the four write pulse sequence. For chip erase, the RY/ \overline{BY} is valid after the rising edge of the sixth \overline{WE} pulse in the six write pulse sequence. For sector erase, the RY/ \overline{BY} is also valid after the rising edge of the sixth \overline{WE} pulse.

Since the RY/BY pin is an open-drain output, several RY/BY pins can be tied together in parallel with a pull-up resistor to $V_{CC}.$

| | 00 | | |
|--|--------------|---------|------------|
| Mode | DQ7 | DQ6 | DQ2 |
| Program | DQ7 | Toggles | 1 |
| Erase | 0 | Toggles | Toggles |
| Erase-Suspend Read (Note 1) (Erase-Suspended Sector) | 1 | 1 | Toggles |
| Erase Suspend Program | DQ7 (Note 2) | Toggles | 1 (Note 2) |

Table 7. Toggle Bit Status

Notes:

1. These status flags apply when outputs are read from a sector that has been erase suspended.

2. These status flags apply when outputs are read from the addresses of the non-erase suspended sector.

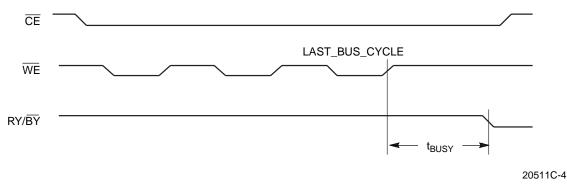


Figure 1. RY/BY Timing Diagram

RESET: Hardware Reset Pin

The RESET pin is an active low signal. A logic '0' on this pin will force the device out of any mode that is currently executing back to the reset state. This allows a system reset to take effect immediately without having to wait for the device to finish a long execution cycle. To avoid a potential bus contention during a system reset, the device is isolated from the data I/O bus by tri-stating the data output pins for the duration of the RESET pulse.

If $\overrightarrow{\text{RESET}}$ is asserted during a program or erase operation, the RY/BY pin will remain low until the reset operation is internally complete. This will require between 1 µs and 20 µs. Hence the RY/BY pin can be used to signal that the reset operation is complete. Otherwise, allow for the maximum reset time of 20 µs. If $\overrightarrow{\text{RESET}}$ is asserted when a program or erase operation is not executing (RY/\overline{BY} pin is high), the reset operation will be complete within 500 ns.

Asserting RESET during a program or erase operation leaves erroneous data stored in the address locations being operated on at the time of device reset. These locations need updating after the reset operation is complete. See Figure 2 for timing specifications.

The device enters I_{CC4} standby mode (200 nA) when $V_{SS} \pm 0.3 V$ is applied to the RESET pin. The device can enter this mode at any time, regardless of the logical condition of the \overline{CE} pin. Furthermore, entering I_{CC4} during a program or erase operation leaves erroneous data in the address locations being operated on at the time of the RESET pulse. These locations need updating after the device resumes standard operations. After the RESET pin goes high, a minimum latency period of 50 ns must occur before a valid read can take place.

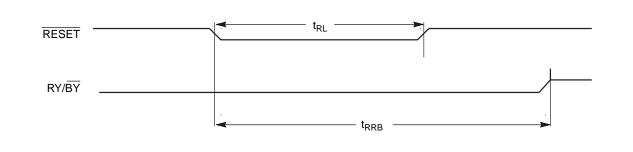


Figure 2. Device Reset During a Program or Erase Operation

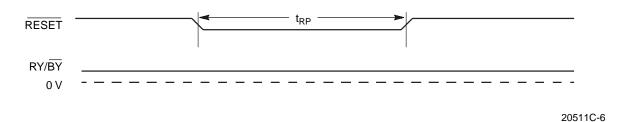


Figure 3. Device Reset During Read Mode

Data Protection

The Am29LV008 is designed to offer protection against accidental erasure or programming caused by spurious system level signals that may exist during power transitions. During power-up, the device automatically resets the internal state machine to the read mode. Also, with its control register architecture, alteration of the memory contents only occurs after successful completion of the command sequences.

The Am29LV008 incorporates several features to prevent inadvertent write cycles resulting from V_{CC} power-up and power-down transitions or system noise.

Low V_{CC} Write Inhibit

To avoid initiation of a write cycle during V_{CC} power-up and power-down, a write cycle is locked out for V_{CC} less than V_{LKO} (lock-out voltage). If V_{CC} < V_{LKO}, the command register is disabled and all internal program/ erase circuits are disabled. Under this condition, the device will reset to read mode. Subsequent writes will be ignored until the V_{CC} level is greater than V_{LKO}. It is the user's responsibility to ensure that the control levels are logically correct when V_{CC} is above V_{LKO} (unless the RESET pin is asserted).

Write Pulse "Glitch" Protection

Noise pulses of less than 5 ns (typical) on \overline{OE} , \overline{CE} , or \overline{WE} will not change the command registers.

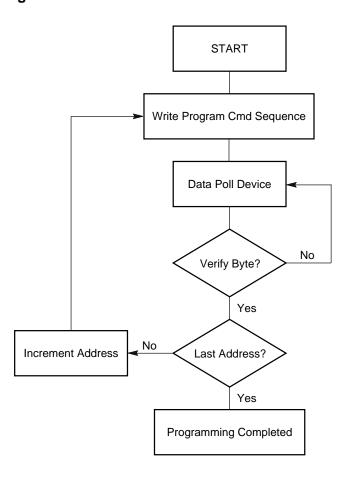
Logical Inhibit

Writing is inhibited by holding any one of $\overline{OE} = V_{IL}$, $\overline{CE} = V_{IH}$, or $\overline{WE} = V_{IH}$. To initiate a write, \overline{CE} and \overline{WE} must be logical zero while \overline{OE} is a logical one.

Power-Up Write Inhibit

Power up of the device with $\overline{WE} = \overline{CE} = V_{IL}$ and $\overline{OE} = V_{IH}$ will not accept commands on the rising edge of \overline{WE} . The internal state machine is automatically reset to read mode on power up.

EMBEDDED ALGORITHMS Embedded Program Algorithm



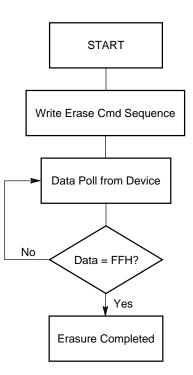
20511C-7

Figure 4. Embedded Program Algorithm

| Bus Operation | Command Sequence | Comments |
|---------------|------------------|--------------------------------------|
| Standby* | | |
| Write | Program | Valid Address/Data |
| Read | | DATA Polling to Verify Programming |
| Standby* | | Compare Data Output to Data Expected |

* Device is either powered-down, erase inhibit, or program inhibit.

Embedded Erase Algorithm



20511C-8

Figure 5. Embedded Erase Algorithm

| Bus Operation | Command Sequence | Comments |
|---------------|------------------|--------------------------------|
| Standby | | |
| Write | Erase | |
| Read | | DATA Polling to Verify Erasure |
| Standby | | Compare Output to FFH |

Data Polling Algorithm

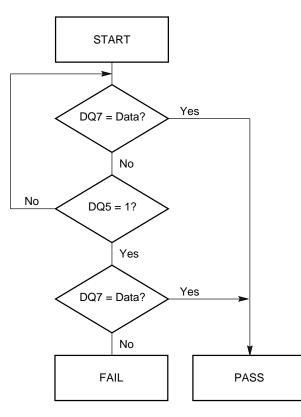
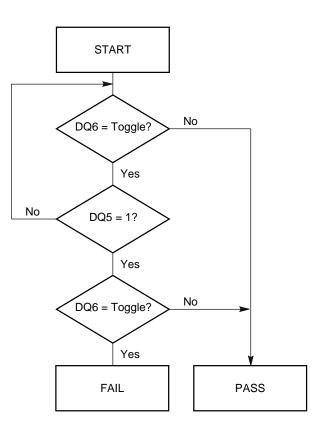


Figure 6. Data Polling Algorithm

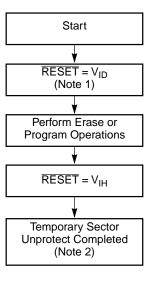
Toggle Bit Algorithm



20511C-10

Figure 7. Toggle Bit Algorithm

Temporary Sector Unprotect Algorithm



Notes:

1. All protected sectors unprotected.

2. All previously protected sectors are protected once again.

20511C-11

Figure 8. Temporary Sector Unprotect Algorithm

ABSOLUTE MAXIMUM RATINGS

| Storage Temperature Plastic Packages |
|---|
| Ambient Temperature with Power Applied |
| Voltage with Respect to Ground All pins except A9, OE and RESET (Note 1)0.5 V to V _{CC} +0.5 V |
| V _{CC} (Note 1)0.5 V to +3.6 V |
| A9, $\overline{\text{OE}},$ and $\overline{\text{RESET}}$ (Note 2)0.5 V to +13.0 V |
| Output Short Circuit Current (Note 3) 200 mA |
| Notes: 1. Minimum DC voltage on input or I/O pins is -0.5 V. During |

- *voltage transitions, input or I/O pins may undershoot* V_{SS} *to -2.0 V for periods of up to 20 ns. Maximum DC voltage on input or I/O pins is* V_{CC} +0.5 *V. During voltage transitions, input or I/O pins may overshoot to* V_{CC} +2.0 *V for periods up to 20 ns. See Tables 10 and 11.*
- Minimum DC input voltage on pins A9, OE, and RESET is -0.5 V. During voltage transitions, A9, OE, and RESET may undershoot V_{SS} to -2.0 V for periods of up to 20 ns. Maximum DC input voltage on pin A9 is +12.5 V which may overshoot to 14.0 V for periods up to 20 ns. See Tables 10 and 11.
- 3. No more than one output may be shorted to ground at a time. Duration of the short circuit should not be greater than one second.
- 4. Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational sections of this data sheet is not implied. Exposure of the device to absolute maximum rating conditions for extended periods may affect device reliability.

OPERATING RANGES

Commercial (C) Devices

| Ambient Temperature (T_A) 0°C to +70°C |
|---|
| Industrial (I) Devices |
| Ambient Temperature (T_A) 40°C to +85°C |
| Extended (E) Devices |
| Ambient Temperature (T_A) –55°C to +125°C |
| V _{CC} Supply Voltages |
| V_{CC} for Am29LV008T/B-90R +3.0 V to 3.6 V |
| V _{CC} for Am29LV008T/B-100, -120, -150 |

Operating ranges define those limits between which the functionality of the device is guaranteed.

DC CHARACTERISTICS

CMOS Compatible

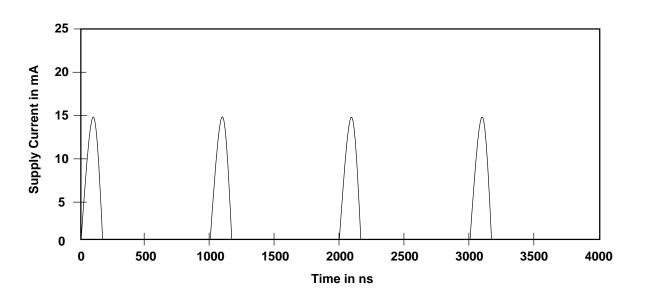
| Parameter Symbol | Parameter Description | Test Conditions | Min | Max | Unit |
|---------------------|--|--|-----------------------|-----------------------|------|
| ILI | Input Load Current | $V_{IN} = V_{SS}$ to V_{CC} , $V_{CC} = V_{CC max}$ | | ±1.0 | μΑ |
| I _{LIT} | A9 Input Load Current | V _{CC} = V _{CC max} ; A9 = 13.0 V | | 35 | μΑ |
| I _{LO} | Output Leakage Current | $V_{OUT} = V_{SS}$ to V_{CC} , $V_{CC} = V_{CC max}$ | | ±1.0 | μΑ |
| | V _{CC} Active Current | $\overline{CE} = V_{IL}, \overline{OE} = V_{IH}$ at 5 MHz | | 16 | mA |
| I _{CC1} | (Note 1) | $\overline{CE} = V_{IL}, \overline{OE} = V_{IH}$ at 1 MHz | | 4 | mA |
| I _{CC2} | V _{CC} Active Current (Notes 1, 2, and 4) | $\overline{CE} = V_{IL,} \overline{OE} = V_{IH}$ | | 30 | mA |
| I _{CC3} | V _{CC} Standby Current | $\frac{V_{CC} = V_{CC max};}{CE, RESET} = V_{CC} \pm 0.3 V$ | | 5 | μΑ |
| I _{CC4} | V _{CC} Standby Current During Reset | $\frac{V_{CC} = V_{CC \text{ max}}; \overline{CE} = V_{CC} \pm 0.3 \text{ V};}{\overline{RESET} = V_{SS} \pm 0.3 \text{ V}}$ | | 5 | μΑ |
| I _{CC5} | Automatic Sleep Mode (Note 3) | $V_{IH} = V_{CC} \pm 0.3 \text{ V}; V_{IL} = V_{SS} \pm 0.3 \text{ V}$ | | 5 | μΑ |
| V _{IL} | Input Low Voltage | | -0.5 | 0.8 | V |
| V _{IH} | Input High Voltage | | 0.7 x V _{CC} | V _{CC} + 0.3 | V |
| V _{ID} | Voltage for Autoselect and Temporary Sector Unprotect | V _{CC} = 3.3 V | 11.5 | 12.5 | V |
| V _{OL} | Output Low Voltage | I_{OL} = 4.0 mA, V_{CC} = $V_{CC min}$ | | 0.45 | V |
| V _{OH1} | | I_{OH} = -2.0 mA, V_{CC} = $V_{CC min}$ | 0.85 V _{CC} | | V |
| V _{OH2} | Output High Voltage | I_{OH} = -100 μ A, V_{CC} = $V_{CC min}$ | V _{CC} -0.4 | | |
| V _{LKO} | Low V _{CC} Lock-Out Voltage (Note 4) | | 2.3 | 2.5 | V |

Notes:

 The I_{CC} current listed includes both the DC operating current and the frequency dependent component (at 5 MHz). The frequency component typically is less than 2 mA/MHz, with OE at V_{IH}.

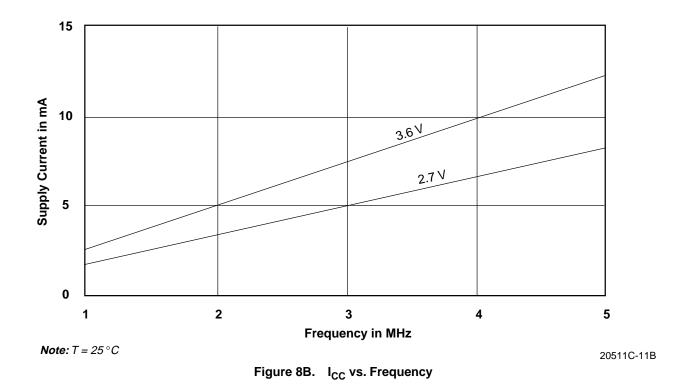
- 2. I_{CC} active while Embedded Erase or Embedded Program is in progress.
- 3. Automatic sleep mode enables the low power mode when addresses remain stable for 200 ns. Typical sleep mode current is 200 nA.
- 4. Not 100% tested.

DC CHARACTERISTICS (CONTINUED)



Note: Addresses are switching at 1 MHz

Figure 8A. I_{CC} Current vs. Time



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AC CHARACTERISTICS

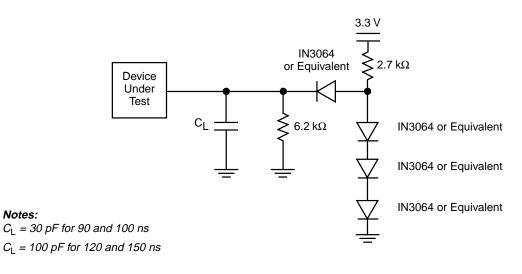
Read-Only Operations Characteristics

| Parameter Symbols | | | | | Speed Option (Note 1) | | | | |
|-------------------|--------------------|---|--|-----|-----------------------|------|------|------|------|
| JEDEC | Standard | Description | Test Setup | | -90R | -100 | -120 | -150 | Unit |
| t _{AVAV} | t _{RC} | Read Cycle Time (Note 3) | | Min | 90 | 100 | 120 | 150 | ns |
| t _{AVQV} | t _{ACC} | Address to Output Delay | $\frac{\overline{CE}}{\overline{OE}} = V_{IL}$ | Max | 90 | 100 | 120 | 150 | ns |
| t _{ELQV} | t _{CE} | Chip Enable to Output Delay | $\overline{OE} = V_{IL}$ | Max | 90 | 100 | 120 | 150 | ns |
| t _{GLQV} | t _{OE} | Output Enable to Output Delay | | Max | 40 | 40 | 50 | 55 | ns |
| t _{EHQZ} | t _{DF} | Chip Enable to Output High Z (Notes 2, 3) | | Max | 30 | 30 | 30 | 40 | ns |
| t _{GHQZ} | t _{DF} | Output Enable to Output High Z (Notes 2, 3) | | Max | 30 | 30 | 30 | 40 | ns |
| t _{AXQX} | t _{OH} | Output Hold Time From Addresses, \overline{CE} or \overline{OE} , Whichever Occurs First (Note 3) | | Min | 0 | 0 | 0 | 0 | ns |
| | t _{Ready} | RESET Pin Low to Read Mode (Note 3) | | Max | 20 | 20 | 20 | 20 | μs |

Notes:

1. Test Conditions Input Rise and Fall Times: 5 ns Input Pulse Levels: 0.0 V to 3.0 V Timing Measurement Reference Level: Input: 1.5 V Output: 1.5 V

- 2. Output Driver Disable Time
- 3. Not 100% tested.



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Notes:

AC CHARACTERISTICS

Write (Erase/Program) Operations

| Parameter Symbols | | | | | | | | | |
|--------------------|--------------------|--|-------------------------------------|-----|------|------|------|------|------|
| JEDEC | - | Description | | | -90R | -100 | -120 | -150 | Unit |
| t _{AVAV} | t _{WC} | Write Cycle Ti | me (Note 2) | Min | 90 | 100 | 120 | 150 | ns |
| t _{AVWL} | t _{AS} | Address Setup | Time | Min | 0 | 0 | 0 | 0 | ns |
| t _{WLAX} | t _{AH} | Address Hold | Time | Min | 50 | 50 | 50 | 65 | ns |
| t _{DVWH} | t _{DS} | Data Setup Time | | Min | 50 | 50 | 50 | 65 | ns |
| t _{WHDX} | t _{DH} | Data Hold Tim | е | Min | 0 | 0 | 0 | 0 | ns |
| | t _{OES} | Output Enable | Setup Time (Note 2) | Min | 0 | 0 | 0 | 0 | ns |
| | | Output | Read (Note 2) | Min | 0 | 0 | 0 | 0 | ns |
| | t _{OEH} | Enable Hold Time | Toggle and Data Polling (Note 2) | Min | 10 | 10 | 10 | 10 | ns |
| t _{GHWL} | t _{GHWL} | Read Recovery Time Before Write (OE High to WE Low) | | Min | 0 | 0 | 0 | 0 | ns |
| t _{ELWL} | t _{CS} | CE Setup Time | | Min | 0 | 0 | 0 | 0 | ns |
| t _{WHEH} | t _{CH} | CE Hold Time | | Min | 0 | 0 | 0 | 0 | ns |
| t _{WLWH} | t _{WP} | Write Pulse Width | | Min | 50 | 50 | 50 | 65 | ns |
| t _{WHWL} | t _{WPH} | Write Pulse Width High | | Min | 30 | 30 | 30 | 35 | ns |
| t _{WHWH1} | t _{WHWH1} | Programming | Operation | Тур | 9 | 9 | 9 | 9 | μs |
| t _{WHWH2} | t _{WHWH2} | Sector Erase (| Operation (Note 1) | Тур | 1 | 1 | 1 | 1 | sec |
| | t _{VCS} | V _{CC} Setup Tim | ne | Min | 50 | 50 | 50 | 50 | μs |
| | t _{RB} | Write Recover | y Time from RY/BY | Min | 0 | 0 | 0 | 0 | ns |
| | t _{RH} | RESET High T | ime Before Read | Min | 50 | 50 | 50 | 50 | ns |
| | t _{RPD} | RESET To Pov | ver Down Time | Min | 20 | 20 | 20 | 20 | μs |
| | t _{BUSY} | Program/Erase | e Valid to RY/BY Delay | Min | 90 | 90 | 90 | 90 | ns |
| | t _{VIDR} | Rise Time to V _{ID} | | Min | 500 | 500 | 500 | 500 | ns |
| | t _{RP} | RESET Pulse Width | | Min | 500 | 500 | 500 | 500 | ns |
| | t _{RRB} | RESET Low to | RY/BY High | Max | 20 | 20 | 20 | 20 | μs |
| | t _{RSP} | RESET Setup Unprotect | Time for Temporary Sector | Min | 4 | 4 | 4 | 4 | μs |

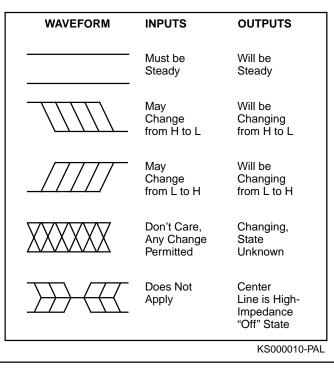
3.0 V-only Flash

Notes:

1. The duration of the program or erase operation is variable and is calculated in the internal algorithms.

2. Note 100% tested.

KEY TO SWITCHING WAVEFORMS



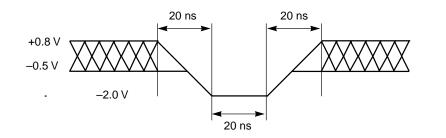
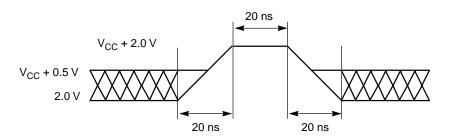


Figure 10. Maximum Negative Overshoot Waveform

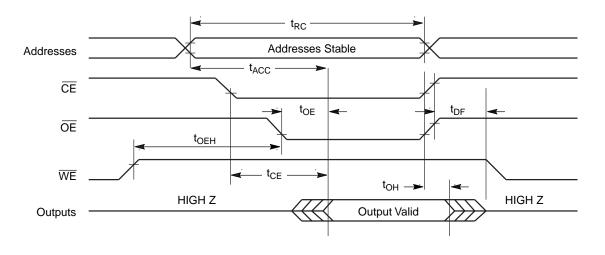


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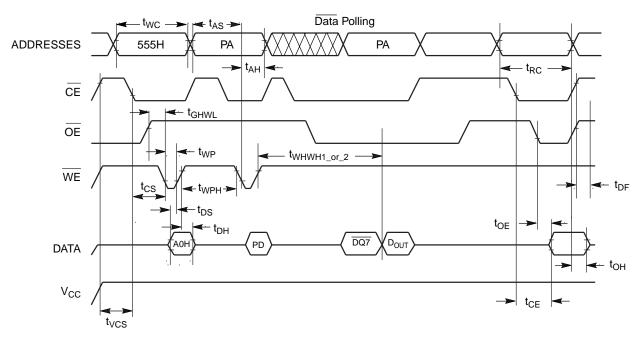
3.0 V-only Flash

SWITCHING WAVEFORMS



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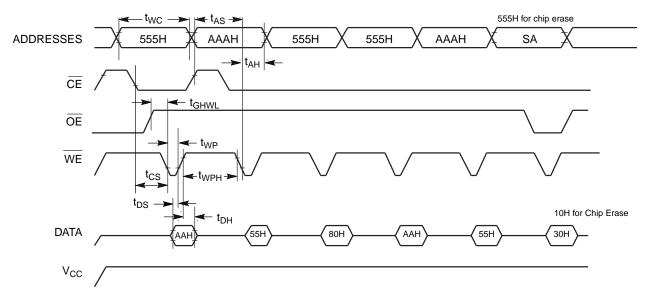


Notes:

- 1. $\overline{DQ7}$ is the output of the complement of the data written to the device.
- 2. D_{OUT} is the output of the data written to the device.
- 3. PA is the address of the memory location to be programmed.
- 4. PD is the data to be programmed at the byte address.
- 5. Illustration shows the last two cycles of a four-bus-cycle sequence..

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Figure 13. AC Waveforms for Program Operations

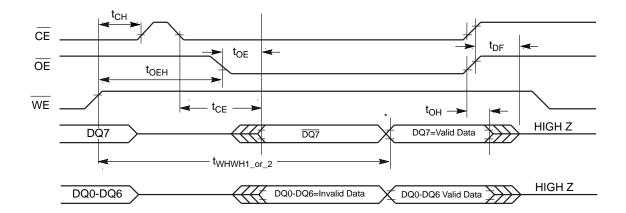


Note:

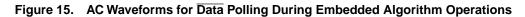
1. SA is the sector address for Sector Erase.

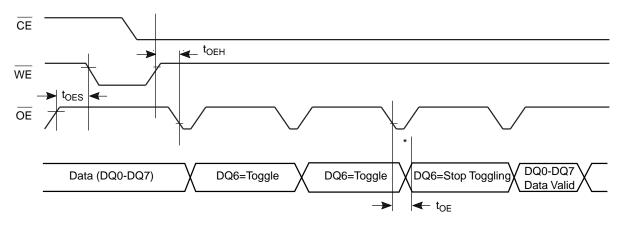
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* DQ7 = Valid Data (The device has completed the embedded operation.)

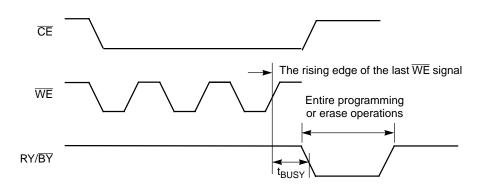




DQ6 stops toggling (The device has completed the embedded operation.)

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Figure 16. AC Waveforms for Toggle Bit During Embedded Algorithm Operations



DQ7 = Valid Data (The device has completed the embedded operation.)

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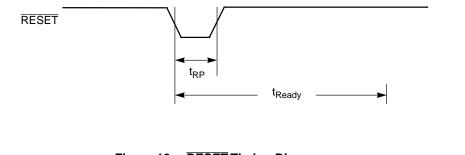


Figure 18. **RESET** Timing Diagram

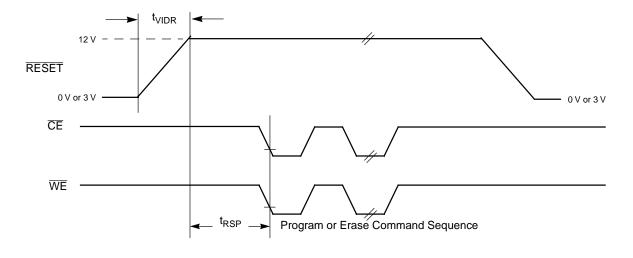


Figure 19. Temporary Sector Unprotect Timing Diagram

AC CHARACTERISTICS

Write (Erase/Program) Operations

Alternate CE Controlled Writes

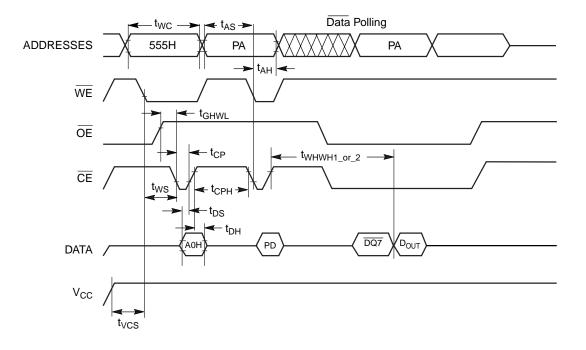
| Paramet | er Symbols | | | | | | | | |
|--------------------|--------------------|--------------------------------|----------------------------------|-----|------|------|------|------|------|
| JEDEC | Standard | Description | Description | | -90R | -100 | -120 | -150 | Unit |
| t _{AVAV} | t _{WC} | Write Cycle Tin | ne (Note 1) | Min | 90 | 100 | 120 | 150 | ns |
| t _{AVEL} | t _{AS} | Address Setup Time | | Min | 0 | 0 | 0 | 0 | ns |
| t _{ELAX} | t _{AH} | Address Hold T | ime | Min | 50 | 50 | 50 | 65 | ns |
| t _{DVEH} | t _{DS} | Data Setup Time | | Min | 50 | 50 | 50 | 65 | ns |
| t _{EHDX} | t _{DH} | Data Hold Time |) | Min | 0 | 0 | 0 | 0 | ns |
| | t _{OES} | Output Enable | Setup Time | Min | 0 | 0 | 0 | 0 | ns |
| | | Output Enable | Read (Note 1) | Min | 0 | 0 | 0 | 0 | ns |
| | t _{OEH} | Hold Time | Toggle and Data Polling (Note 1) | Min | 10 | 10 | 10 | 10 | ns |
| t _{GHEL} | t _{GHEL} | Read Recovery (OE High to W | / Time Before Write E Low) | Min | 0 | 0 | 0 | 0 | ns |
| t _{WLEL} | t _{WS} | WE Setup Time | 9 | Min | 0 | 0 | 0 | 0 | ns |
| t _{EHWH} | t _{WH} | WE Hold Time | | Min | 0 | 0 | 0 | 0 | ns |
| t _{ELEH} | t _{CP} | CE Pulse Width | ו | Min | 50 | 50 | 50 | 65 | ns |
| t _{EHEL} | t _{CPH} | CE Pulse Width High | | Min | 30 | 30 | 30 | 35 | ns |
| t _{WHWH1} | t _{WHWH1} | Programming (| Operation | Тур | 9 | 9 | 9 | 9 | μs |
| t _{WHWH2} | t _{WHWH2} | Sector Erase C | peration (Note 3) | Тур | 1 | 1 | 1 | 1 | sec |

Notes:

1. Not 100% tested.

2. The duration of the program or erase operation is variable and is calculated in the internal algorithms.

3. Does not include the preprogramming time.



Notes:

- 1. PA is address of the memory location to be programmed.
- 2. PD is data to be programmed at byte address.
- 3. $\overline{DQ7}$ is the complement of the data written to the device.
- 4. D_{OUT} is the data written to the device.
- 5. Figure indicates last two bus cycles of four bus cycle sequence.

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Figure 20. Alternate CE Controlled Write Operation Timings

ERASE AND PROGRAMMING PERFORMANCE

| Parameter | Typ (Note 2) | Max (Note 3) | Unit | Comments |
|-------------------------|--------------|--------------|--------|--------------------------------------|
| Sector Erase Time | 1 | 15 | S | Excludes 00h programming |
| Chip Erase Time | 19 | | S | prior to erasure (Note 4) |
| Byte Programming Time | 9 | 300 | μs | Excludes system level overhead |
| Chip Programming Time | 9 | 27 | s | (Note 5) |
| Erase/Program Endurance | 1,000,000 | | cycles | Minimum 100,000 cycles guaranteed |

Notes:

1. The typical program and erase times are considerably less than the maximum times since most bytes program or erase significantly faster than the worst case byte. The device enters the failure mode (DQ5="1") only after the maximum times given are exceeded. See the section on DQ5 for further information.

- 2. Except for erase and program endurance, the typical program and erase times assume the following conditions: 25°C, 3.0 V V_{CC}, 100,000 cycles. Additionally, programming typicals assume checkerboard pattern.
- 3. Under worst case conditions of 90 $^{\circ}$ C, V_{CC} = 2.7 V, 100,000 cycles.
- 4. In the pre-programming step of the Embedded Erase algorithm, all bytes are programmed to 00h before erasure.
- 5. System-level overhead is the time required to execute the four-bus-cycle sequence for the program command. See Table 5 for further information on command definitions.

LATCHUP CHARACTERISTICS

| | Min | Мах |
|---|---------|-------------------------|
| Input voltage with respect to $V_{\mbox{\scriptsize SS}}$ on all pins except I/O pins (including A9, $\overline{\mbox{\scriptsize OE}},$ and $\overline{\mbox{\scriptsize RESET}})$ | -1.0 V | 13.0 V |
| Input voltage with respect to $V_{\mbox{\scriptsize SS}}$ on all I/O pins | -1.0 V | V _{CC} + 1.0 V |
| V _{CC} Current | -100 mA | +100 mA |

Includes all pins except V_{CC} . Test conditions: $V_{CC} = 3.0$ V, one pin at a time.

TSOP PIN CAPACITANCE (Notes 1–2)

| Parameter Symbol | Parameter Description | Test Setup | Тур | Max | Unit |
|---------------------|-------------------------|----------------------|-----|-----|------|
| C _{IN} | Input Capacitance | V _{IN} = 0 | 6 | 7.5 | pF |
| C _{OUT} | Output Capacitance | V _{OUT} = 0 | 8.5 | 12 | pF |
| C _{IN2} | Control Pin Capacitance | V _{IN} = 0 | 7.5 | 9 | pF |

Notes:

1. Sampled, not 100% tested.

2. Test conditions $T_A = 25^{\circ}C$, f = 1.0 MHz.

DATA SHEET REVISION SUMMARY FOR AM29LV008

Distinctive Characteristics:

Rearranged bullets. Renamed "2.7 to 3.6 volt, extended voltage range ... " to "Single power supply operation." Under "Single power supply operation" and "High performance" bullets, defined standard and extended voltage ranges and added 90 ns speed option. Combined "Advanced power management" and "Low current consumption" bullets into new "Ultra low power consumption" bullet. Under that bullet, revised the typical standby and automatic sleep mode current specifications from 1 µA to 200 nA; revised read current specification from 10 mA to 2 mA/MHz. Combined "Sector protection" and "Flexible sector architecture" bullets. Under flexible sector architecture bullet, added temporary sector unprotect feature description. Combined Embedded Program and Embedded Erase bullets under new "Embedded Algorithms" bullet; removed ™ designations. Clarified descriptions of sector protection, erase suspend/resume, hardware reset pin, ready/busy pin, and data polling and toggle bits.

General Description:

Added text on new speed option and voltage range to the second paragraph.

Product Selector Guide:

Added -90R voltage range and speed option.

Pin Configuration:

Added new voltage range for -90R to V_{CC} specification.

Ordering Information, Standard Products:

The -90R speed option is now listed in the example. Revised "Speed Option" section to indicate both voltage ranges.

Valid Combinations: Added -90R speed option and voltage range.

Automatic Sleep Mode:

Revised addresses stable time to 200 ns and current draw to 200 nA.

Table 5, Command Definitions:

Grouped address designators PA, PD, RA, RD, and SA under the legend heading. Modified SA definition to accommodate the sector protect verify command. Since unlock addresses only require address bits A0–A10 to be valid, the number of hexadecimal digits in the unlock addresses were changed from four to three. The remaining upper address bits are don't care. Removed "H" designation from hexadecimal values in table and replaced with new Note 1. Revised Notes 5 and 6 to indicate when commands are valid; are now new Notes 4 and 5. Expanded autoselect section to show each function separately: manufacturer ID, device ID, and sector protect verify. Added note 3 to explain sector protect codes. In Note 8, changed A13 to A11, added "unless otherwise noted"; is now new Note 6.

RESET: Hardware Reset Pin:

Fourth paragraph: Revised standby mode specification to 200 nA.

Operating Ranges:

 V_{CC} Supply Voltages: Added 3.0 to 3.6 V voltage range and -90R speed option.

DC Characteristics:

CMOS Compatible: Changed I_{CC1} from 30 mA maximum at 6 MHz to 16 mA maximum at 5 MHz and 4 mA maximum at 1 MHz. Changed I_{CC2} from 35 mA to 30 mA maximum. In the V_{OL} specification, changed the I_{OL} test condition from 5.8 to 4.0 mA. In Note 1, changed 6 MHz to 5 MHz. In Note 3, changed address stable time from 300 ns to 200 ns; changed typical automatic sleep mode current from 1 μ A to 200 nA.

Figure 8A, I_{CC} Current vs. Time, and Figure 8B, I_{CC} vs. Frequency:

Figure 8A illustrates current draw during the Automatic Sleep Mode after the addresses are stable. Figure 8B shows how frequency affects the current draw curves for both voltage ranges.

AC Characteristics:

Read Only Operations Characteristics: Added -90R column.

Test Conditions, Figure 9:

Added 90 ns speed to C₁ note.

AC Characteristics:

Write/Erase/Program Operations: Added the -90R column.

Figure 13, AC Waveforms for Program Operations:

Changed 5555H to 555H in addresses waveform to match command definitions (Table 5).

Figure 14, AC Waveforms for Chip/Sector Erase Operations:

Changed 5555H to 555H in addresses waveform to match command definitions (Table 5).

Figure 19, Temporary Sector Unprotect Diagram:

Corrected callouts on RESET waveform to "0 V or 3 V".

AC Characteristics:

Alternate \overline{CE} Controlled Writes: Added the -90R column. Changed t_{AH} from 45 to 50 ns for -100, from 50 to 65 ns for -150. Changed t_{DS} from 50 to 65 ns for -150. Changed t_{CP} from 45 to 50 ns for -100, from 50 to 65 ns for -150. Changed t_{CPH} from 20 to 30 ns for -100, -120; from 20 to 35 ns for -150.

Figure 20, Alternate CE Controlled Write Operation Timings:

Changed 5555H to 555H in addresses waveform to match command definitions (Table 5).

Erase and Programming Performance:

Added typical chip erase specification. Renamed erase/program cycles specification to erase/program endurance. Corrected to indicate 1,000,000 cycle endurance is typical, not maximum, and that 100,000

cycle endurance is minimum, not typical. Revised Note 1 to include write endurance; moved Note 1 references in table to table head. Consolidated and moved Note 1 and Note 3 references in table to table head. Combined Note 2 and Note 5 into new Note 1, which applies to the entire table; revised to indicate that DQ5=1 after any maximum time. Comments for program and erase now straddle parameter rows. Separated the two sentences in Note 4 into new Notes 4 and 5; added corresponding note references to comment section.